# Pulse Discharge, High Voltage, High Temperature 200°C COG Dielectric, 1,000 VDC – 3,500 VDC (Industrial Grade)



#### **Overview**

KEMET's Industrial Grade Pulse Discharge Series surface mount capacitors in COG Dielectric deliver reliable high voltage and high temperature performance required for operation in harsh environments, specifically discharge circuitry. Constructed of a robust and proprietary base metal electrode (BME) dielectric system, these devices offer industry-leading performance relative to capacitance and case size. KEMET Pulse Discharge capacitors average greater than 30% higher breakdown voltage than competitive precious metal electrode (PME) devices with similar capacitance & voltage ratings.

Designed for down-hole oil exploration and perforation, these devices feature a 200°C maximum operating temperature. The Electronics Industries Alliance (EIA) characterizes COG dielectric as a Class I material. Components of this classification are temperature compensating and are suited for resonant circuit applications or those where Q and stability of capacitance characteristics are required. Pulse Discharge series capacitors in COG dielectric exhibit no change in capacitance with respect to time and voltage and boast a negligible change in capacitance with reference to ambient temperature. These devices retain high insulation resistance with low dissipation factor at elevated temperatures up 200°C.

KEMET's Pulse Discharge surface mount MLCCs are manufactured in state-of-the-art ISO/TS 16949:2009 certified facilities and are proven to function reliably in harsh, high temperature and high humidity, down-hole environments.



# **Ordering Information**

| С       | 2824                         | Н                                  | 393                                                  | K                               | U                                                             | G          | W                          | C                                             | TU                                                           |
|---------|------------------------------|------------------------------------|------------------------------------------------------|---------------------------------|---------------------------------------------------------------|------------|----------------------------|-----------------------------------------------|--------------------------------------------------------------|
| Ceramic | Case Size<br>(L" x W")       | Specification/<br>Series           | Capacitance<br>Code (pF)                             | Capacitance<br>Tolerance        | Dielectric<br>Withstanding<br>Voltage (VDC) <sup>1</sup>      | Dielectric | Failure<br>Rate/<br>Design | Termination Finish <sup>2</sup>               | Packaging/<br>Grade<br>(C-Spec) <sup>3</sup>                 |
|         | 2824<br>3040<br>3640<br>4540 | H = High<br>temperature<br>(200°C) | Two<br>significant<br>digits +<br>number of<br>zeros | J = ±5%<br>K = ±10%<br>M = ±20% | D = 1,000<br>U = 1,250<br>G = 2,000<br>H = 3,000<br>V = 3,500 | G = COG    | W = Pulse<br>discharge     | C = 100% Matte Sn<br>L = SnPb (5% Pb minimum) | See "Packaging<br>C-Spec Ordering<br>Options Table"<br>below |

<sup>1</sup> DWV is the voltage a capacitor can withstand (survive) for a short period of time. It exceeds the nominal and continuous working voltage of the capacitor. See waterfall table for working voltage.

<sup>2</sup> Additional termination finish options may be available. Contact KEMET for details.

<sup>3</sup> Additional reeling or packaging options may be available. Contact KEMET for details.



# Packaging C-Spec Ordering Options Table

| Packaging Type/Options <sup>1</sup>                  | Packaging<br>Ordering Code (C-Spec) <sup>2</sup> |
|------------------------------------------------------|--------------------------------------------------|
| 7" Reel (Embossed Plastic Tape)/Unmarked             | TU                                               |
| 13" Reel (Embossed Plastic Tape)/Unmarked            | 7210                                             |
| Reel (Embossed Plastic Tape)/Unmarked – 50 pieces    | T050                                             |
| Reel (Embossed Plastic Tape)/Unmarked – 100 pieces   | T100                                             |
| Reel (Embossed Plastic Tape)/Unmarked – 250 pieces   | T250                                             |
| Reel (Embossed Plastic Tape)/Unmarked – 500 pieces   | T500                                             |
| Reel (Embossed Plastic Tape)/Unmarked – 1,000 pieces | T1K0                                             |

<sup>1</sup> The terms "Marked" and "Unmarked" pertain to laser marking option of components. All packaging options labeled as "Unmarked" will contain capacitors that have not been laser marked. The option to laser mark is not available on these devices.

<sup>2</sup> Reeling quantities are dependent upon chip size and thickness dimension. When ordering using the "Txxx" packaging ordering codes (C-Specs) outlined above, product may be shipped on multiple 7" reels or a single 13" reel. Additional reeling or packaging options may be available. Contact KEMET for details.

#### **Benefits**

- Operating temperature range of -55°C to +200°C
- Lead (Pb)-free, RoHS and REACH compliant
- Base metal technology
- Higher UVBD capability than competitive dielectric technologies
- · Capacitance offerings ranging from 2.2 nF up to 150 nF
- Available capacitance tolerances of ±5%, ±10% or ±20%
- · Extremely low ESR and ESL
- High thermal stability

- · High ripple current capability
- No capacitance change with respect to applied rated DC voltage
- Negligible capacitance change with respect to temperature from -55°C to +200°C
- · No capacitance decay with time
- · Non-polar device, minimizing installation concerns
- 100% pure matte tin-plated termination finish allowing for excellent solderability

# **Applications**

Typical applications include high temperature discharge circuits for munitions and down-hole oil exploration/perforation.



### **Dimensions – Millimeters (Inches)**



| Size Code | L<br>Length                 | W<br>Width                  | T<br>Thickness<br>Maximum | B<br>Bandwidth | S<br>Separation<br>Minimum | Mounting<br>Technique |
|-----------|-----------------------------|-----------------------------|---------------------------|----------------|----------------------------|-----------------------|
| 2824      | 7.10±0.40<br>(0.280±0.016)  | 6.10±0.40<br>(0.240±0.016)  |                           |                |                            |                       |
| 3040      | 7.60±0.40<br>(0.300±0.016)  | 10.20±0.40<br>(0.402±0.016) | See Table 2               | 1.27±0.40      | N//A                       | Solder                |
| 3640      | 9.10±0.40<br>(0.358±0.016)  | 10.20±0.40<br>(0.402±0.016) | See Table 2               | (0.050±0.016)  | N/A                        | Reflow Only           |
| 4540      | 11.40±0.40<br>(0.449±0.016) | 10.20±0.40<br>(0.402±0.016) |                           |                |                            |                       |

#### **Qualification/Certification**

Industrial grade pulse discharge products are subject to internal qualification. Details regarding test methods and conditions are referenced in Table 4, Performance and Reliability.

#### **Environmental Compliance**

Lead (Pb)-free, RoHS, and REACH compliant without exemptions (excluding SnPb termination finish option).



# **Electrical Parameters/Characteristics**

| Item                                                                  | Parameters/Characteristics                                                        |
|-----------------------------------------------------------------------|-----------------------------------------------------------------------------------|
| Operating Temperature Range                                           | -55°C to +200°C                                                                   |
| Capacitance Change with Reference to<br>+25°C and 0 VDC Applied (TCC) | ±30 ppm/°C                                                                        |
| Aging Rate (Maximum % Capacitance Loss/Decade Hour)                   | 0%                                                                                |
| <sup>1</sup> Dielectric Withstanding Voltage (DWV)                    | See product selection table (product waterfall) for available ratings             |
| <sup>2</sup> Dissipation Factor (DF) Maximum Limit at 25°C            | 0.1%                                                                              |
| <sup>3</sup> Insulation Resistance (IR) Minimum Limit at 25°C         | 1,000 megohm microfarads or 100 GΩ<br>(500 VDC applied for 120±5 seconds at 25°C) |

<sup>1</sup> DWV is the voltage a capacitor can withstand (survive) for a short period of time. It exceeds the nominal and continuous working voltage of the capacitor.

<sup>2</sup> Capacitance and dissipation factor (DF) measured under the following conditions:

1 MHz ±100 kHz and 1.0 Vrms ±0.2 V if capacitance ≤ 1,000 pF

1 kHz ± 50 Hz and 1.0 Vrms ±0.2 V if capacitance > 1,000 pF

<sup>3</sup> To obtain IR limit, divide  $M\Omega$ - $\mu$ F value by the capacitance and compare to G $\Omega$  limit. Select the lower of the two limits.

Note: When measuring capacitance it is important to ensure the set voltage level is held constant. The HP4284 and Agilent E4980 have a feature known as Automatic Level Control (ALC). The ALC feature should be switched to "ON."

#### **Post Environmental Limits**

|            | High Temperature Life, Biased Humidity, Moisture Resistance |                      |                                   |                      |                          |  |  |  |  |  |  |
|------------|-------------------------------------------------------------|----------------------|-----------------------------------|----------------------|--------------------------|--|--|--|--|--|--|
| Dielectric | Rated DC<br>Voltage                                         | Capacitance<br>Value | Dissipation Factor<br>(Maximum %) | Capacitance<br>Shift | Insulation<br>Resistance |  |  |  |  |  |  |
| COG        | All                                                         | All                  | 0.5                               | 0.3% or ±0.25 pF     | 10% of Initial<br>Limit  |  |  |  |  |  |  |

# **Electrical Characteristics**



#### Energy Density vs. Applied Voltage

#### Discharge Current vs. Applied Voltage





# Table 1 – Pulse Discharge Series, Capacitance Range Waterfall

|             |             |         | se Siz<br>Series       |        |      | C      | 2824   | н      |        |      | C      | 3040   | ЭН     |        |                  | C      | 3640   | ЭН     |        |      | C    | 454(   | ЭН     |        |
|-------------|-------------|---------|------------------------|--------|------|--------|--------|--------|--------|------|--------|--------|--------|--------|------------------|--------|--------|--------|--------|------|------|--------|--------|--------|
|             |             | Vo      | ltage Co               | de     | D    | U      | G      | Н      | v      | D    | U      | G      | н      | V      | D                | U      | G      | Н      | V      | D    | U    | G      | н      | v      |
| Capacitance | Cap<br>Code |         | ric Withs<br>Itage (DW |        | 1000 | 1250   | 2000   | 3000   | 3500   | 1000 | 1250   | 2000   | 3000   | 3500   | 1000             | 1250   | 2000   | 3000   | 3500   | 1000 | 1250 | 2000   | 3000   | 3500   |
|             |             | Wor     | king Volt              | age    | 500  | 630    | 1000   | 1500   | 2000   | 500  | 630    | 1000   | 1500   | 2000   | 500              | 630    | 1000   | 1500   | 2000   | 500  | 630  | 1000   | 1500   | 2000   |
|             |             | Capacit | tance Tol              | erance |      |        |        |        |        |      |        |        |        |        | d Chip<br>Thickr |        |        |        |        |      |      |        |        |        |
| 1,800 pF    | 182         | J       | K                      | М      |      |        |        |        |        |      |        |        |        |        |                  |        |        |        |        |      |      |        |        |        |
| 2,000 pF    | 202         | J       | K                      | М      |      |        |        |        |        |      |        |        |        |        |                  |        |        |        |        |      |      |        |        |        |
| 2,200 pF    | 222         | J       | K                      | М      | TA   | TA     | TA     | TA     | TA     |      |        |        |        |        |                  |        |        |        |        |      |      |        |        |        |
| 2,700 pF    | 272         | J       | K                      | М      | TA   | TA     | TA     | TA     | TA     |      |        |        |        |        |                  |        |        |        |        |      |      |        |        |        |
| 3,300 pF    | 332         | J       | K                      | М      | TA   | TA     | TA     | TA     | TA     | QB   | QB     | QB     | QB     | QB     |                  |        |        |        |        |      |      |        |        |        |
| 3,900 pF    | 392         | J       | K                      | М      | TA   | TA     | TA     | TA     | TB     | QB   | QB     | QB     | QB     | QB     | MA               | MA     | MA     | MA     | MA     |      |      |        |        |        |
| 4,700 pF    | 472         | J       | K                      | М      | TA   | TA     | TA     | ТΒ     | TB     | QB   | QB     | QB     | QB     | QB     | MA               | MA     | MA     | MA     | MA     | SA   | SA   | SA     | SA     | SA     |
| 5,600 pF    | 562         | J       | K                      | М      | TA   | TA     | TA     | ТΒ     | TC     | QB   | QB     | QB     | QB     | QB     | MA               | MA     | MA     | MA     | MA     | SA   | SA   | SA     | SA     | SA     |
| 6,800 pF    | 682         | J       | K                      | М      | TA   | TA     | TA     | ТΒ     |        | QB   | QB     | QB     | QB     | QC     | MA               | MA     | MA     | MA     | MA     | SA   | SA   | SA     | SA     | SA     |
| 8,200 pF    | 822         | J       | K                      | М      | TA   | TA     | TA     | тс     |        | QB   | QB     | QB     | QC     | QC     | MA               | MA     | MA     | MA     | MB     | SA   | SA   | SA     | SA     | SA     |
| 10,000 pF   | 103         | J       | K                      | М      | TA   | TA     | TA     |        |        | QB   | QB     | QB     | QC     | QD     | MA               | MA     | MA     | MA     | MB     | SA   | SA   | SA     | SA     | SB     |
| 12,000 pF   | 123         | J       | K                      | М      | TA   | TA     | TA     |        |        | QB   | QB     | QB     | QD     |        | MA               | MA     | MA     | MB     | MB     | SA   | SA   | SA     | SA     | SB     |
| 15,000 pF   | 153         | J       | K                      | М      | TA   | TA     | TB     |        |        | QB   | QB     | QB     | QD     |        | MA               | MA     | MA     | MB     | MC     | SA   | SA   | SA     | SB     | SB     |
| 18,000 pF   | 183         | J       | K                      | М      | TA   | TA     | TB     |        |        | QB   | QB     | QB     |        |        | MA               | MA     | MA     | MC     |        | SA   | SA   | SA     | SB     | SC     |
| 22,000 pF   | 223         | J       | K                      | М      | TA   | TB     | TC     |        |        | QB   | QB     | QC     |        |        | MA               | MA     | MA     |        |        | SA   | SA   | SA     | SB     |        |
| 27,000 pF   | 273         | J       | K                      | М      | TA   | TB     |        |        |        | QB   | QB     | QC     |        |        | MA               | MA     | MA     |        |        | SA   | SA   | SA     | SC     |        |
| 33,000 pF   | 333         | J       | K                      | М      | ΤB   | TB     |        |        |        | QB   | QC     | QC     |        |        | MA               | MA     | MB     |        |        | SA   | SA   | SA     |        |        |
| 39,000 pF   | 393         | J       | ĸ                      | м      | ΤВ   | TC     |        |        |        | QB   | QC     | QD     |        |        | MA               | MA     | MB     |        |        | SA   | SA   | SB     |        |        |
| 47,000 pF   | 473         | J       | к                      | м      | ΤВ   |        |        |        |        | QB   | QC     |        |        |        | MA               | MB     | мс     |        |        | SA   | SA   | SB     |        |        |
| 56,000 pF   | 563         | J       | к                      | м      | тс   |        |        |        |        | QC   | QD     |        |        |        | MA               | MB     |        |        |        | SA   | SA   | SB     |        |        |
| 68,000 pF   | 683         | J       | к                      | м      |      |        |        |        |        | QC   | QD     |        |        |        | MB               | мс     |        |        |        | SA   | SB   | SC     |        |        |
| 82,000 pF   | 823         | J       | К                      | М      |      |        |        |        |        | QC   |        |        |        |        | MB               |        |        |        |        | SA   | SB   |        |        |        |
| 0.10 µF     | 104         | J       | К                      | М      |      |        |        |        |        | QD   |        |        |        |        | мс               |        |        |        |        | SB   | SC   |        |        |        |
| 0.12 µF     | 124         | J       | К                      | м      |      |        |        |        |        |      |        |        |        |        | MC               |        |        |        |        | SB   |      |        |        |        |
| 0.15 µF     | 154         | J       | К                      | м      |      |        |        |        |        |      |        |        |        |        |                  |        |        |        |        | SC   |      |        |        |        |
|             |             | Wor     | king Volt              | age    | 500  | 630    | 1000   | 1500   | 2000   | 500  | 630    | 1000   | 1500   | 2000   | 500              | 630    | 1000   | 1500   | 2000   | 500  | 630  | 1000   | 1500   | 2000   |
| Conceitone  | Cap         |         | ric Withs<br>tage (DW  |        | 1000 | 1250 ( | 2000 1 | 3000 1 | 3500 2 | 1000 | 1250 ( | 2000 1 | 3000 1 | 3500 2 | 1000             | 1250 ( | 2000 1 | 3000 1 | 3500 2 | 1000 | 1250 | 2000 1 | 3000 1 | 3500 2 |
| Capacitance | Code        |         |                        | D      | U    | G      | H      | V      | D      | U    | G      | H      | V      | D      | U                | G      | H      | V      | D      | U    | G    | H      | V      |        |
|             |             | Case    | Size/S                 | eries  |      | C      | 2824   | H      | 1      |      | C      | 3040   | H      | I      |                  | C      | 3640   | H      | 1      |      | C    | 4540   | H      |        |

These products are protected under US Patents 7,172,985 and 7,670,981, other patents pending, and any foreign counterparts.



| Thickness | Case | Thickness ± | Paper C | )uantity | Plastic (        | Quantity |  |
|-----------|------|-------------|---------|----------|------------------|----------|--|
| Code      | Size | Range (mm)  | 7" Reel | 13" Reel | 7" Reel          | 13" Reel |  |
| TA        | 2824 | 1.40 ± 0.15 | 0       | 0        | 750              | 2,500    |  |
| TB        | 2824 | 2.00 ± 0.20 | 0       | 0        | 300              | 2,000    |  |
| TC        | 2824 | 2.50 ± 0.20 | 0       | 0        | 300              | 2,000    |  |
| QB        | 3040 | 1.40 ± 0.15 | 0       | 0        | 500              | 1,650    |  |
| QC        | 3040 | 2.00 ± 0.20 | 0       | 0        | 500              | 1,650    |  |
| QD        | 3040 | 2.50 ± 0.20 | 0       | 0        | 350              | 1,400    |  |
| MA        | 3640 | 1.40 ± 0.15 | 0       | 0        | 250              | 1,550    |  |
| MB        | 3640 | 2.00 ± 0.20 | 0       | 0        | 250              | 1,550    |  |
| MC        | 3640 | 2.50 ± 0.20 | 0       | 0        | 250              | 1,000    |  |
| SA        | 4540 | 1.40 ± 0.15 | 0       | 0        | 200              | 1,500    |  |
| SB        | 4540 | 2.00 ± 0.20 | 0       | 0        | 200              | 1,500    |  |
| SC        | 4540 | 2.50 ± 0.20 | 0       | 0        | 200              | 1,500    |  |
| Thickness | Case | Thickness ± | 7" Reel | 13" Reel | 7" Reel          | 13" Reel |  |
| Code      | Size | Range (mm)  | Paper C | )uantity | Plastic Quantity |          |  |

# Table 2 – Chip Thickness/Tape & Reel Packaging Quantities

Package quantity based on finished chip thickness specifications.



# Table 3 – Chip Capacitor Land Pattern Design Recommendations per IPC-7351

| Size<br>Code<br>(In.) | Metric<br>Size<br>Code | l    | Density Level A:<br>Maximum (Most)<br>Land Protrusion (mm) |       |       |       |      | Density Level B:<br>Median (Nominal)<br>Land Protrusion (mm) |       |       |       | Density Level C:<br>Minimum (Least)<br>Land Protrusion (mm) |      |       |       |       |
|-----------------------|------------------------|------|------------------------------------------------------------|-------|-------|-------|------|--------------------------------------------------------------|-------|-------|-------|-------------------------------------------------------------|------|-------|-------|-------|
| ()                    |                        | C    | Y                                                          | X     | V1    | V2    | C    | Y                                                            | X     | V1    | V2    | C                                                           | Y    | X     | V1    | V2    |
| 2824                  | 7260                   | 3.45 | 1.70                                                       | 6.60  | 9.60  | 7.60  | 3.35 | 1.50                                                         | 6.50  | 8.70  | 7.00  | 3.25                                                        | 1.30 | 6.40  | 8.00  | 6.70  |
| 3040                  | 7610                   | 3.70 | 1.70                                                       | 10.70 | 10.10 | 11.70 | 3.60 | 1.50                                                         | 10.60 | 9.20  | 11.10 | 3.50                                                        | 1.30 | 10.50 | 8.50  | 10.80 |
| 3640                  | 9210                   | 4.45 | 1.70                                                       | 10.70 | 11.60 | 11.70 | 4.35 | 1.50                                                         | 10.60 | 10.70 | 11.10 | 4.25                                                        | 1.30 | 10.50 | 10.00 | 10.80 |
| 4540                  | -                      | 5.60 | 1.70                                                       | 10.70 | 13.90 | 11.70 | 5.50 | 1.50                                                         | 10.60 | 13.00 | 11.10 | 5.40                                                        | 1.30 | 10.50 | 12.30 | 10.80 |

Density Level A: For low-density product applications. Provides a wider process window for reflow solder processes.

**Density Level B:** For products with a moderate level of component density. Provides a robust solder attachment condition for reflow solder processes. **Density Level C:** For high component density product applications. Before adapting the minimum land pattern variations, the user should perform qualification testing based on the conditions outlined in IPC Standard 7351 (IPC-7351).

Image below based on Density Level B for a 3640 case size.





### **Soldering Process**

#### **Recommended Soldering Technique:**

Solder reflow only

#### **Recommended Reflow Soldering Profile:**

KEMET's families of surface mount multilayer ceramic capacitors (SMD MLCCs) are compatible with wave (single or dual), convection, IR or vapor phase reflow techniques. Preheating of these components is recommended to avoid extreme thermal stress. KEMET's recommended profile conditions for convection and IR reflow reflect the profile conditions of the IPC/J-STD-020 standard for moisture sensitivity testing. These devices can safely withstand a maximum of three reflow passes at these conditions.

| Profile Feature                                                  | Terminati             | ion Finish            |  |  |
|------------------------------------------------------------------|-----------------------|-----------------------|--|--|
| Tomereature                                                      | SnPb                  | 100% Matte Sn         |  |  |
| Preheat/Soak                                                     |                       |                       |  |  |
| Temperature Minimum (T <sub>Smin</sub> )                         | 100°C                 | 150°C                 |  |  |
| Temperature Maximum (T <sub>Smax</sub> )                         | 150°C                 | 200°C                 |  |  |
| Time ( $t_s$ ) from $T_{smin}$ to $T_{smax}$                     | 60 – 120 seconds      | 60 – 120 seconds      |  |  |
| Ramp-Up Rate (T <sub>L</sub> to T <sub>P</sub> )                 | 3°C/second<br>maximum | 3°C/second<br>maximum |  |  |
| Liquidous Temperature $(T_L)$                                    | 183°C                 | 217°C                 |  |  |
| Time Above Liquidous ( $t_L$ )                                   | 60 – 150 seconds      | 60 – 150 seconds      |  |  |
| Peak Temperature (T <sub>P</sub> )                               | 235°C                 | 260°C                 |  |  |
| Time Within 5°C of Maximum<br>Peak Temperature (t <sub>p</sub> ) | 20 seconds<br>maximum | 30 seconds<br>maximum |  |  |
| Ramp-Down Rate $(T_p to T_L)$                                    | 6°C/second<br>maximum | 6°C/second<br>maximum |  |  |
| Time 25°C to Peak<br>Temperature                                 | 6 minutes<br>maximum  | 8 minutes<br>maximum  |  |  |

Note 1: All temperatures refer to the center of the package, measured on the capacitor body surface that is facing up during assembly reflow.





# Table 4 – Performance & Reliability: Test Methods and Conditions

| F                              | Product Qualification Test Plan                                              |
|--------------------------------|------------------------------------------------------------------------------|
| Reliability/E                  | Environmental Tests per MIL-STD-202//JESD22                                  |
| Load Humidity                  | 85°C/85%RH and 200 VDC maximum, 1,000 Hours                                  |
| Low Voltage Humidity           | 85°C/85%RH, 1.5V, 1,000 Hours                                                |
| Temperature Cycling            | -55°C to +200°C, 50 Cycles                                                   |
| Thermal Shock                  | -55°C to +150°C, 20 seconds transfer, 15 minute dwell, 300 Cycles            |
| Moisture Resistance            | Cycled Temp/RH 0 V, 10 cycles at 24 hours each                               |
| Physical, Mecha                | nical & Process Tests per MIL-STD 202/JIS-C-6429                             |
| Resistance to Solvents         | Include Aqueous wash chemical – OKEM Clean or equivalent                     |
| Mechanical Shock and Vibration | Method 213: Figure 1, Condition F Method 204: 5 gs for 20 minutes, 12 cycles |
| Resistance to Soldering Heat   | Condition B, no per-heat of samples, Single Wave Solder                      |
| Terminal Strength              | Force of 1.8 kg for 60 seconds                                               |
| Board Flex                     | Appendix 2, Note: 3.0 mm (minimum)                                           |

#### Storage and Handling

Ceramic chip capacitors should be stored in normal working environments. While the chips themselves are quite robust in other environments, solderability will be degraded by exposure to high temperatures, high humidity, corrosive atmospheres, and long term storage. In addition, packaging materials will be degraded by high temperature–reels may soften or warp and tape peel force may increase. KEMET recommends that maximum storage temperature not exceed 40°C and maximum storage humidity not exceed 70% relative humidity. Temperature fluctuations should be minimized to avoid condensation on the parts and atmospheres should be free of chlorine and sulfur bearing compounds. For optimized solderability chip stock should be used promptly, preferably within 1.5 years of receipt.



### Construction



# **Capacitor Marking (Optional):**

Laser marking option is not available on:

- COG, Ultra Stable X8R and Y5V dielectric devices
- · EIA 0402 case size devices
- EIA 0603 case size devices with Flexible Termination option.
- KPS Commercial and Automotive grade stacked devices.

These capacitors are supplied unmarked only.

# Packaging

Please contact kemet for details regarding available packaging options.



# **Tape & Reel Packaging Information**

KEMET offers multilayer ceramic chip capacitors packaged in 8, 12, 16 and 24 mm tape on 7" and 13" reels in accordance with EIA Standard 481. This packaging system is compatible with all tape-fed automatic pick and place systems. See Table 2 for details on reeling quantities for commercial chips.



# Table 5 – Carrier Tape Configuration, Embossed Plastic & Punched Paper (mm)

|                   | Таре | Embosse | ed Plastic         | Punche                   | d Paper  |          |  |
|-------------------|------|---------|--------------------|--------------------------|----------|----------|--|
| EIA Case Size     | Size | 7" Reel | 13" Reel           | 7" Reel                  | 13" Reel |          |  |
|                   | (W)* | Pitch   | (P <sub>1</sub> )* | Pitch (P <sub>1</sub> )* |          |          |  |
| 01005 - 0402      | 8    |         |                    | 2                        | 2        |          |  |
| 0603              | 8    |         |                    | 2/4                      | 2/4 -    | $\vdash$ |  |
| 0805              | 8    | 4       | 4                  | 4                        | 4        |          |  |
| 1206 - 1210       | 8    | 4       | 4                  | 4                        | 4        |          |  |
| 1805 - 1808       | 12   | 4       | 4                  |                          |          |          |  |
| ≥ 1812            | 12   | 8       | 8                  |                          |          |          |  |
| 2824              | 16   | 12      | 12                 |                          |          |          |  |
| 3040 - 4540       | 24   | 16      | 16                 |                          |          |          |  |
| KPS 1210          | 12   | 8       | 8                  |                          |          |          |  |
| KPS 1812 & 2220   | 16   | 12      | 12                 |                          |          |          |  |
| Array 0508 & 0612 | 8    | 4       | 4                  |                          |          |          |  |

\*Refer to Figures 1 and 2 for W and P<sub>1</sub> carrier tape reference locations. \*Refer to Tables 6 and 7 for tolerance specifications.

#### New 2 mm Pitch Reel Options\*

| Packaging<br>Ordering Code<br>(C-Spec) | Packaging Type/Options             |
|----------------------------------------|------------------------------------|
| C-3190                                 | Automotive grade 7" reel unmarked  |
| C-3191                                 | Automotive grade 13" reel unmarked |
| C-7081                                 | Commercial grade 7" reel unmarked  |
| C-7082                                 | Commercial grade 13" reel unmarked |

\* 2 mm pitch reel only available for 0603 EIA case size.

2 mm pitch reel for 0805 EIA case size under development.

#### Benefits of Changing from 4 mm to 2 mm Pitching Spacing

- Lower placement costs
- Double the parts on each reel results in fewer reel changes and increased efficiency
- Fewer reels result in lower packaging, shipping and storage costs, reducing waste



# Figure 1 – Embossed (Plastic) Carrier Tape Dimensions



# Table 6 – Embossed (Plastic) Carrier Tape Dimensions

Metric will govern

| Constant Dimensions — Millimeters (Inches) |                                            |                            |                            |                            |                           |                                  |                                                 |                  |  |
|--------------------------------------------|--------------------------------------------|----------------------------|----------------------------|----------------------------|---------------------------|----------------------------------|-------------------------------------------------|------------------|--|
| Tape Size                                  | D <sub>o</sub>                             | E <sub>1</sub>             | P <sub>0</sub>             | P <sub>2</sub>             | R Reference<br>Note 2     | S <sub>1</sub> Minimum<br>Note 3 | T<br>Maximum                                    | T1<br>Maximum    |  |
| 8 mm                                       |                                            |                            |                            |                            | 25.0<br>(0.984)           |                                  |                                                 |                  |  |
| 12 mm                                      | 1.5+0.10/-0.0<br>(0.059+0.004/-0.0)        | 1.75±0.10<br>(0.069±0.004) | 4.0±0.10<br>(0.157±0.004)  | 2.0±0.05<br>(0.079±0.002)  | 30                        | 0.600<br>(0.024)                 | 0.600<br>(0.024)                                | 0.100<br>(0.004) |  |
| 16 mm                                      |                                            |                            |                            |                            | (1.181)                   |                                  |                                                 |                  |  |
| 24 mm                                      | 1.5+0.10/-0.0<br>(0.059+0.004/-0.0)        | 1.75±0.10<br>(0.069±0.004) | 4.0±0.10<br>(0.157±0.004)  | 2.0±0.10<br>(0.078±0.003)  | 30<br>(1.181)             | 5<br>(0.196)                     | 0.250<br>(0.009)                                | 0.350<br>(0.013) |  |
|                                            | Variable Dimensions – Millimeters (Inches) |                            |                            |                            |                           |                                  |                                                 |                  |  |
| Tape Size                                  | Pitch                                      | E₂<br>Minimum              | F                          | P <sub>1</sub>             | T <sub>2</sub><br>Maximum | W<br>Maximum                     | A <sub>0</sub> ,B <sub>0</sub> & K <sub>0</sub> |                  |  |
| 8 mm                                       | Single (4 mm)                              | 6.25<br>(0.246)            | 3.5±0.05<br>(0.138±0.002)  | 4.0±0.10<br>(0.157±0.004)  | 2.5<br>(0.098)            | 8.3<br>(0.327)                   |                                                 |                  |  |
| 12 mm                                      | Single (4 mm) &<br>Double (8 mm)           | 10.25<br>(0.404)           | 5.5±0.05<br>(0.217±0.002)  | 8.0±0.10<br>(0.315±0.004)  | 4.6<br>(0.181)            | 12.3<br>(0.484)                  | Not                                             | o F              |  |
| 16 mm                                      | Triple (12 mm)                             | 14.25<br>(0.561)           | 7.5±0.05<br>(0.138±0.002)  | 12.0±0.10<br>(0.157±0.004) | 4.6<br>(0.181)            | 16.3<br>(0.642)                  | Note 5                                          |                  |  |
| 24 mm                                      | 16 mm                                      | 22.25<br>(0.875)           | 11.5±0.10<br>(0.452±0.003) | 16.0±0.10<br>(0.629±0.004) | 3<br>(0.118)              | 24.3<br>(0.956)                  |                                                 |                  |  |

1. The embossment hole location shall be measured from the sprocket hole controlling the location of the embossment. Dimensions of embossment location and hole location shall be applied independent of each other.

2. The tape with or without components shall pass around R without damage (see Figure 6).

3. If S, < 1.0 mm, there may not be enough area for cover tape to be properly applied (see EIA Standard 481 paragraph 4.3 section b).

4. B, dimension is a reference dimension for tape feeder clearance only.

5. The cavity defined by  $A_{\mu}$ ,  $B_{\mu}$  and  $K_{\mu}$  shall surround the component with sufficient clearance that:

(a) the component does not protrude above the top surface of the carrier tape.

(b) the component can be removed from the cavity in a vertical direction without mechanical restriction, after the top cover tape has been removed.

(c) rotation of the component is limited to 20° maximum for 8 and 12 mm tapes and 10° maximum for 16 mm tapes (see Figure 3).

(d) lateral movement of the component is restricted to 0.5 mm maximum for 8 and 12 mm wide tape and to 1.0 mm maximum for 16 mm tape (see Figure 4).

(e) for KPS Series product,  $A_n$  and  $B_n$  are measured on a plane 0.3 mm above the bottom of the pocket.

(f) see Addendum in EIA Standard 481 for standards relating to more precise taping requirements.



# Figure 2 – Punched (Paper) Carrier Tape Dimensions



# Table 7 – Punched (Paper) Carrier Tape Dimensions

Metric will govern

| Constant Dimensions – Millimeters (Inches) |                                     |                            |                           |                           |                            |                 |                       |
|--------------------------------------------|-------------------------------------|----------------------------|---------------------------|---------------------------|----------------------------|-----------------|-----------------------|
| Tape Size                                  | D <sub>0</sub>                      | E <sub>1</sub>             | P <sub>0</sub>            | P <sub>2</sub>            | T <sub>1</sub> Maximum     | G Minimum       | R Reference<br>Note 2 |
| 8 mm                                       | 1.5+0.10/-0.0<br>(0.059+0.004/-0.0) | 1.75±0.10<br>(0.069±0.004) | 4.0±0.10<br>(0.157±0.004) | 2.0±0.05<br>(0.079±0.002) | 0.10<br>(0.004)<br>Maximum | 0.75<br>(0.030) | 2<br>(0.984)          |
| Variable Dimensions – Millimeters (Inches) |                                     |                            |                           |                           |                            |                 |                       |
| Tape Size                                  | Pitch                               | E2 Minimum                 | F                         | P <sub>1</sub>            | T Maximum                  | W Maximum       | $A_0 B_0$             |
| 8 mm                                       | Half (2 mm)                         | 6.25                       | 3.5±0.05<br>(0.138±0.002) | 2.0±0.05<br>(0.079±0.002) | 1.1<br>(0.098)             | 8.3<br>(0.327)  | Note 1                |
| 8 mm                                       | Single (4 mm)                       | (0.246)                    |                           | 4.0±0.10<br>(0.157±0.004) |                            | 8.3<br>(0.327)  |                       |

1. The cavity defined by  $A_{\alpha}$ ,  $B_{\alpha}$  and T shall surround the component with sufficient clearance that:

a) the component does not protrude beyond either surface of the carrier tape.

b) the component can be removed from the cavity in a vertical direction without mechanical restriction, after the top cover tape has been removed.

c) rotation of the component is limited to 20° maximum (see Figure 3).

d) lateral movement of the component is restricted to 0.5 mm maximum (see Figure 4).

e) see Addendum in EIA Standard 481 for standards relating to more precise taping requirements.

2. The tape with or without components shall pass around R without damage (see Figure 6).



#### **Packaging Information Performance Notes**

- 1. Cover Tape Break Force: 1.0 Kg minimum.
- 2. Cover Tape Peel Strength: The total peel strength of the cover tape from the carrier tape shall be:

| Tape Width   | Peel Strength                    |  |  |
|--------------|----------------------------------|--|--|
| 8 mm         | 0.1 to 1.0 Newton (10 to 100 gf) |  |  |
| 12 and 16 mm | 0.1 to 1.3 Newton (10 to 130 gf) |  |  |
| 24 mm        | 0.1 to 1.6 Newton (10 to 160 gf) |  |  |

The direction of the pull shall be opposite the direction of the carrier tape travel. The pull angle of the carrier tape shall be 165° to 180° from the plane of the carrier tape. During peeling, the carrier and/or cover tape shall be pulled at a velocity of 300±10 mm/minute.

**3. Labeling:** Bar code labeling (standard or custom) shall be on the side of the reel opposite the sprocket holes. *Refer to EIA Standards 556 and 624*.

#### Figure 3 – Maximum Component Rotation



#### Figure 4 – Maximum Lateral Movement



#### Figure 5 – Bending Radius





# Figure 6 – Reel Dimensions



Note: Drive spokes optional; if used, dimensions B and D shall apply.

### Table 8 – Reel Dimensions

Metric will govern

| Constant Dimensions — Millimeters (Inches) |                           |                                     |                                       |                            |  |  |  |
|--------------------------------------------|---------------------------|-------------------------------------|---------------------------------------|----------------------------|--|--|--|
| Tape Size                                  | А                         | B Minimum                           | С                                     | D Minimum                  |  |  |  |
| 8 mm                                       | 170.0.00                  |                                     | 13.0+0.5/-0.2<br>(0.521+0.02/-0.008)  |                            |  |  |  |
| 12 mm                                      | 178±0.20<br>(7.008±0.008) | 1.5<br>(0.059)                      |                                       | 20.2<br>(0.795)            |  |  |  |
| 16 mm                                      | or<br>330±0.20            |                                     |                                       | ()                         |  |  |  |
| 24 mm                                      | (13.000±0.008)            | 1.2<br>(0.047)                      | 13.0 + -0.2<br>(0.521 + -0.008)       | 21<br>(0.826)              |  |  |  |
| Variable Dimensions – Millimeters (Inches) |                           |                                     |                                       |                            |  |  |  |
| Tape Size                                  | N Minimum                 | W <sub>1</sub>                      | W <sub>2</sub> Maximum                | W <sub>3</sub>             |  |  |  |
| 8 mm                                       |                           | 8.4+1.5/-0.0<br>(0.331+0.059/-0.0)  | 14.4<br>(0.567)                       |                            |  |  |  |
| 12 mm                                      | 50                        | 12.4+2.0/-0.0<br>(0.488+0.078/-0.0) | 18.4<br>(0.724)                       | Shall accommodate tape     |  |  |  |
| 16 mm                                      | (1.969)                   | 16.4+2.0/-0.0<br>(0.646+0.078/-0.0) | 22.4<br>(0.882)                       | width without interference |  |  |  |
| 24 mm                                      |                           | 25+1.0/-0.0<br>(0.984+0.039/-0.0)   | 27.4+1.0/-1.0<br>(1.078+0.039/-0.039) |                            |  |  |  |



# Figure 7 – Tape Leader & Trailer Dimensions



### Figure 8 – Maximum Camber





### **KEMET Electronics Corporation Sales Offices**

For a complete list of our global sales offices, please visit www.kemet.com/sales.

#### Disclaimer

All product specifications, statements, information and data (collectively, the "Information") in this datasheet are subject to change. The customer is responsible for checking and verifying the extent to which the Information contained in this publication is applicable to an order at the time the order is placed.

All Information given herein is believed to be accurate and reliable, but it is presented without guarantee, warranty, or responsibility of any kind, expressed or implied.

Statements of suitability for certain applications are based on KEMET Electronics Corporation's ("KEMET") knowledge of typical operating conditions for such applications, but are not intended to constitute – and KEMET specifically disclaims – any warranty concerning suitability for a specific customer application or use. The Information is intended for use only by customers who have the requisite experience and capability to determine the correct products for their application. Any technical advice inferred from this Information or otherwise provided by KEMET with reference to the use of KEMET's products is given gratis, and KEMET assumes no obligation or liability for the advice given or results obtained.

Although KEMET designs and manufactures its products to the most stringent quality and safety standards, given the current state of the art, isolated component failures may still occur. Accordingly, customer applications which require a high degree of reliability or safety should employ suitable designs or other safeguards (such as installation of protective circuitry or redundancies) in order to ensure that the failure of an electrical component does not result in a risk of personal injury or property damage.

Although all product-related warnings, cautions and notes must be observed, the customer should not assume that all safety measures are indicted or that other measures may not be required.

KEMET is a registered trademark of KEMET Electronics Corporation.